



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
 United States Patent and Trademark Office
 Address: COMMISSIONER FOR PATENTS
 P.O. Box 1450
 Alexandria, Virginia 22313-1450
www.uspto.gov



CONFIRMATION NO. 1629

Bib Data Sheet

SERIAL NUMBER 10/663,371	FILING DATE 09/16/2003 RULE	CLASS 257	GROUP ART UNIT '2815	ATTORNEY DOCKET NO. Via Interconnect Patent A
-----------------------------	-----------------------------------	--------------	-------------------------	--

APPLICANTS

Volkan H. Ozguz, Aliso Viejo, CA;

Angel A. Pepe, Rancho Palos Verdes, CA;

James Yamaguchi, Laguna Niguel, CA; Andrew Camien, Costa Mesa, CA;
Douglas M. Albert, Yorba Linda, CA;*ppbe*

** CONTINUING DATA *****

This appln claims benefit of 60/410,895 09/16/2002

ppbe

** FOREIGN APPLICATIONS *****

IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** SMALL ENTITY **

** 12/05/2003

Foreign Priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY	SHEETS DRAWING	TOTAL CLAIMS	INDEPENDENT CLAIMS
35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance	CA	5	14	3
Verified and Acknowledged Examiner's Signature	<i>J. Yamaguchi</i>	<i>ppbe</i>			

ADDRESS

W. Eric Boyd, Esq.
 Irvine Sensors Corp.
 Bldg. 3, Suite 108
 3001 Redhill Ave.
 Costa Mesa, CA
 92626

TITLE

Stacked microelectronic module with vertical interconnect vias

FILING FEE	FEES: Authority has been given in Paper	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of
------------	---	---

RECEIVED
450

No. _____ to charge/credit DEPOSIT ACCOUNT
No. _____ for following:

time)
<input type="checkbox"/> 1.18 Fees (Issue)
<input type="checkbox"/> Other _____
<input type="checkbox"/> Credit